

date 08/05/2022

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MODEL: HSS19-B20-NP | DESCRIPTION: HEAT SINK

FEATURES

- TO-220 package
- round hole for component attachment
- · low profile design
- black anodized finish





thermal resistance¹ power dissipation¹ @ 75°C ∆T, nat @ 1 W, @ 1 W, @ 1 W, @ 75°C ∆T, nat 400 LFM conv (°C/W) 200 LFM nat conv conv (°C/W) $(^{\circ}C/W)$ (°C/W) (W) 31.94 7.51 5.84 2.85 HSS-B20-NP-06 26.32

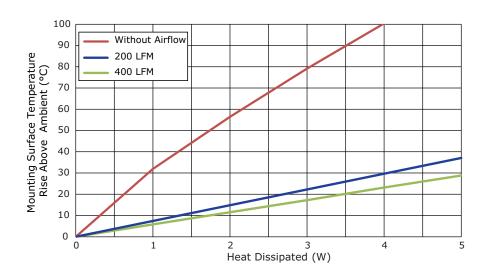
Note: 1. See performance curves for full thermal resistance details.

PERFORMANCE CURVES

	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)		
Power (W)	Natural Conv.	200 LFM	400 LFM
0	0	0	0
1	31.94	7.51	5.84
2	56.44	14.85	11.53
3	79.15	22.50	17.26
4	100.39	30.12	23.17
5	116.77	37.08	28.81

Ths: "hot spot" temperature measured on the heatsink

Ta: ambient temperature

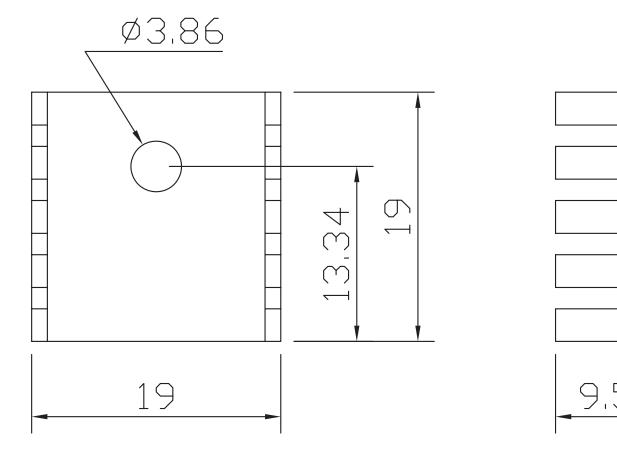


MECHANICAL DRAWING

units: mm

tolerance: ±0.5 mm

MATERIAL	AL1050
FINISH	black anodized
THICKNESS	1.2 mm
WEIGHT	1.7 g



REVISION HISTORY

rev.	description	date
1.0	initial release	03/29/2017
1.01	brand update	02/13/2020
1.02	logo, datasheet style update	08/05/2022

The revision history provided is for informational purposes only and is believed to be accurate.



CUI Devices offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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